NX5DV330

Quad 1-of-2 video multiplexer/demultiplexer Rev. 02 — 25 August 2008

Product data sheet

General description 1.

The NX5DV330 is a quad 1-of-2 high-speed TTL-compatible video multiplexer/demultiplexer. The low ON resistance of the switch allows inputs to be connected to outputs without adding propagation delay or generating additional ground bounce noise

It has a digital select input (S), four independent inputs/outputs (nY0, nY1), a common input/output (nZ) and an active LOW enable input (E). When pin E is HIGH, the switch is turned off.

Schmitt-trigger action at the enable input (\overline{E}) and select input (S) makes the circuit tolerant to slower input rise and fall times across the entire V_{CC} range from 4.0 V to 5.5 V.

The NX5DV330 is characterized for operation from -40 °C to +85 °C.

2. **Features**

- \blacksquare 5 Ω switch connection between two ports
- TTL-compatible input levels
- Minimal propagation delay through the switch
- ESD protection:
 - HBM JESD22-A114E Class 2A exceeds 2000 V
 - MM JESD22-A115-A exceeds 200 V
 - CDM JESD22-C101C exceeds 1000 V
- Latch-up testing is done to JEDEC standard JESD78 which exceeds 100 mA

Ordering information 3.

Table 1. **Ordering information**

 $T_{amb} = -40 \,^{\circ}C$ to $+85 \,^{\circ}C$.

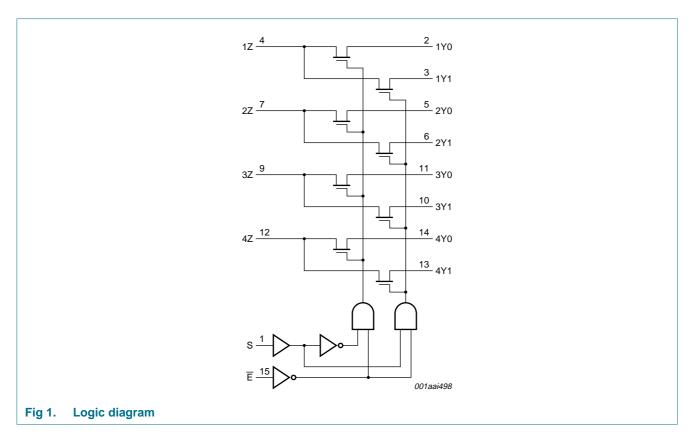
Type number	Package									
	Temperature range	Name	Description	Version						
NX5DV330D	–40 °C to +85 °C	SO16	plastic small outline package; 16 leads; body width 3.9 mm	SOT109-1						
NX5DV330DS	–40 °C to +85 °C	SSOP16[1]	plastic shrink small outline package; 16 leads; body width 3.9 mm; lead pitch 0.635 mm	SOT519-1						
NX5DV330PW	–40 °C to +85 °C	TSSOP16	plastic thin shrink small outline package; 16 leads; body width 4.4 mm	SOT403-1						

^[1] Also known as QSOP16.



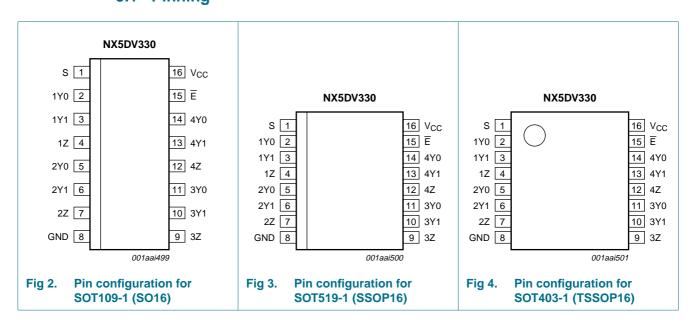
Quad 1-of-2 video multiplexer/demultiplexer

4. Functional diagram



5. Pinning information

5.1 Pinning



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5.2 Pin description

Table 2. Pin description

Symbol	Pin	Description
S	1	select control input
1Y0, 1Y1, 2Y0, 2Y1, 3Y1, 3Y0, 4Y1, 4Y0	2, 3, 5, 6, 10, 11, 13, 14	independent input or output
1Z, 2Z, 3Z, 4Z	4, 7, 9, 12	independent input or output
GND	8	ground (0 V)
Ē	15	enable input (active LOW)
V _{CC}	16	positive supply voltage

6. Functional description

Table 3. Function selection

 $H = HIGH \ voltage \ level; \ L = LOW \ voltage \ level; \ X = Don't \ care.$

Input		Switch
Ē	S	
L	L	Y0 to Z or Z to Y0
L	Н	Y1 to Z or Z to Y1
Н	X	switch off

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{CC}	supply voltage		-0.5	+7.0	V
V_{I}	input voltage		[<u>1]</u> -0.5	+7.0	V
I _{SW}	switch current	continuous current through each switch	-	128	mA
I_{IK}	input clamping current	$V_I < 0 V$	-	-50	mA
T_{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation		[2][3]	500	mW

^[1] The input and output negative voltage ratings may be exceeded if the input and output clamp current ratings are observed.

^[2] For SO16 package: P_{tot} derates linearly with 8 mW/K above 70 °C.

^[3] For SSOP16 (QSOP16) and TSSOP16 packages: Ptot derates linearly with 5.5 mW/K above 60 °C.

Quad 1-of-2 video multiplexer/demultiplexer

8. Recommended operating conditions

Table 5. Operating conditions

All unused control inputs of the device must be held at V_{CC} or GND to ensure proper device operation.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V_{CC}	supply voltage		4.0	5.0	5.5	V
V _{IH}	HIGH-level input voltage		2.0	-	-	V
V_{IL}	LOW-level input voltage		-	-	0.8	V
V_{H}	hysteresis voltage	pin S, E	-	45	-	mV
T _{amb}	ambient temperature	operating in free-air	-40	+25	+85	°C

9. Static characteristics

Table 6. Static characteristics

 $T_{amb} = -40 \,^{\circ}C$ to +85 $^{\circ}C$.

Symbol	Parameter	Conditions	Min	Typ <mark>[1]</mark>	Max	Unit
V_{IK}	input clamping voltage	$V_{CC} = 4.5 \text{ V}; I_I = -18 \text{ mA}$	-	-	-1.2	V
I _I	input leakage current	pin S, \overline{E} ; V_{CC} = 5.5 V; V_I = GND or 5.5 V	-	-	±1	μΑ
I _{S(OFF)}	OFF-state leakage current	V_{CC} = 5.5 V; V_I = GND; V_O = 0 V to 5.5 V	-	-	±1	μΑ
I _{OFF}	power-off leakage current	$V_{CC} = 0 \text{ V}; V_I = V_O = 0 \text{ V to } 5.5 \text{ V}$	-	-	±1	μΑ
I _{CC}	supply current	V_{CC} = 5.5 V; I_{O} = 0 mA; V_{I} = V_{CC} or GND	-	-	3	μΑ
ΔI_{CC}	additional supply current	pin S, \overline{E} ; V_{CC} = 5.5 V; one input at 3.4 V, other inputs at V_{CC} or GND	[2] _	-	2.5	mA
Cı	input capacitance	pin S, \overline{E} ; V _I = 5 V or 0 V	-	3.5	-	pF
$C_{io(off)}$	off-state input/output	Z port; $V_{CC} = 5 \text{ V}$; $V_O = 5 \text{ V}$ or 0 V ; $\overline{E} = V_{CC}$	-	6.0	-	pF
	capacitance	Y port; $V_{CC} = 5 \text{ V}$; $V_{O} = 5 \text{ V}$ or 0 V ; $\overline{E} = V_{CC}$	-	4.0	-	pF
$C_{io(on)}$	on-state input/output capacitance	Z port; $V_{CC} = 5 \text{ V}$; $V_{O} = 5 \text{ V}$ or 0 V; $\overline{E} = \text{GND}$	-	14	-	pF
R _{ON}	ON resistance	V _{CC} = 4.5 V	[3]			
		$V_I = 1.0 \text{ V}; I_I = 13 \text{ mA}$	-	3	7	Ω
		$V_1 = 2.0 \text{ V}; I_1 = 26 \text{ mA}$	-	7	10	Ω

^[1] All typical values are measured at V_{CC} = 5 V; T_{amb} = 25 °C.

10. Dynamic characteristics

Table 7. Dynamic characteristics

 $T_{amb} = -40 \,^{\circ}\text{C}$ to +85 $^{\circ}\text{C}$; for test circuit see Figure 6.

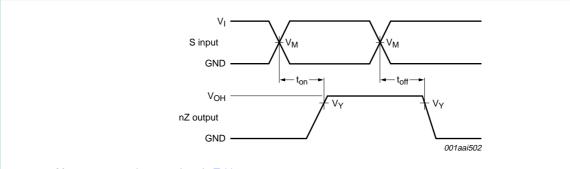
anno						
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
t _{on}	turn-on time	S to nZ; see Figure 5				
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$	-	4.0	6.0	ns
t _{off}	turn-off time	S to nZ; see Figure 5				
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$	-	2.3	6.0	ns
NX5DV330_2					© NXP B.V. 20	008. All rights reserved

^[2] This is the increase in supply current for each input that is at the specified TTL voltage level rather than V_{CC} or GND.

^[3] Measured by the voltage drop between the Z and the Y terminals at the indicated current through the switch. ON-state resistance is determined by the lowest voltage of the two (Z or Y) terminals.

Quad 1-of-2 video multiplexer/demultiplexer

11. Waveforms



Measurement points are given in Table 8.

 $\ensuremath{V_{\text{OH}}}$ is the typical voltage output level that occurs with the output load.

Fig 5. Input (S) to output (nZ) turn-on and turn-off time

Table 8. Measurement points

Supply voltage	Input		Output
V _{CC}	V _I	V _M	V _Y
4.5 V to 5.5 V	GND to 3.0 V	1.5 V	0.9V _{OH}

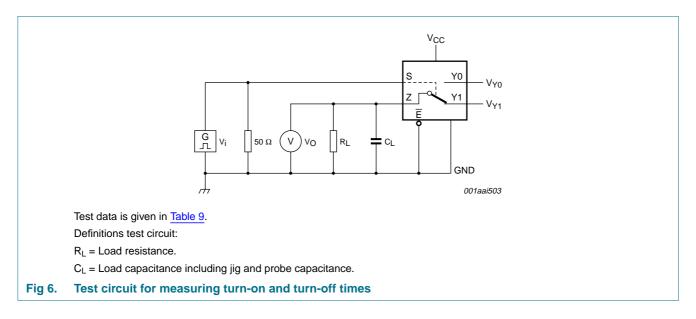


Table 9. Test data

Input		Load				
VI	fi	t _r , t _f	V _{Y0}	V _{Y1}	R _L	C _L
GND to 3.0 V	≤ 10 MHz	≤ 2.5 ns	GND to 3.0 V	3.0 V to GND	75 Ω	20 pF

Quad 1-of-2 video multiplexer/demultiplexer

12. Additional dynamic characteristics

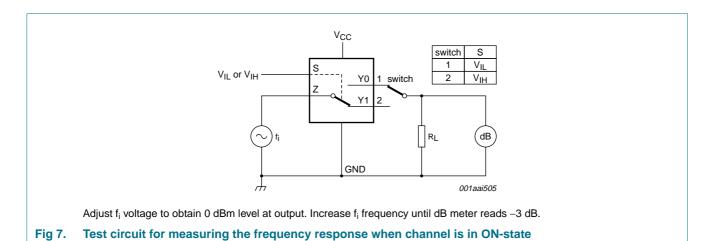
Table 10. Additional dynamic characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); V_l = GND or V_{CC} (unless otherwise specified); T_{amb} = 25 °C; V_{CC} = 4.5 V to 5.5 V.

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
G_{dif}	differential gain	$f_i = 3.58 \text{ MHz}; R_L = 150 \Omega$	'	-	0.64	-	%
φ _{dif}	differential phase	f_i = 3.58 MHz; R_L = 150 Ω		-	0.1	-	deg
$f_{(-3dB)}$	-3 dB frequency response	$R_L = 150 \Omega$; see Figure 7		300	-	-	MHz
α_{iso}	isolation (OFF-state)	f_i = 10 MHz; R_L = 150 Ω ; see Figure 8		-	-60	-	dB
Xtalk	crosstalk	between switches; see Figure 9; f_i = 10 MHz; R_L = 150 Ω ; R_i = 10 Ω	<u>[1]</u>	-	-63	-	dB

^[1] All unused analog input pins (nZ) and outputs pins (nYn) are connected through 10 Ω and 50 Ω pull-down resistors, respectively.

13. Test circuits

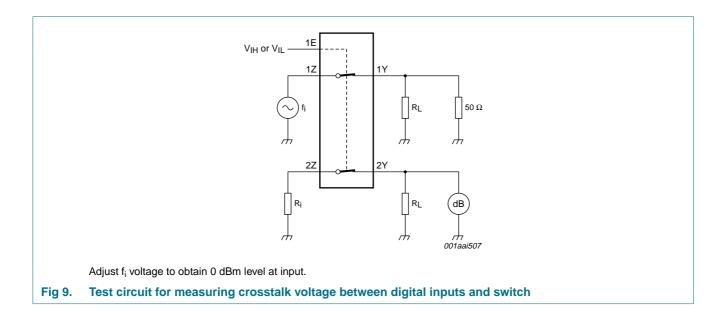


V_{IL} or V_{IH}

V_I or V_I or V_I

V_I or

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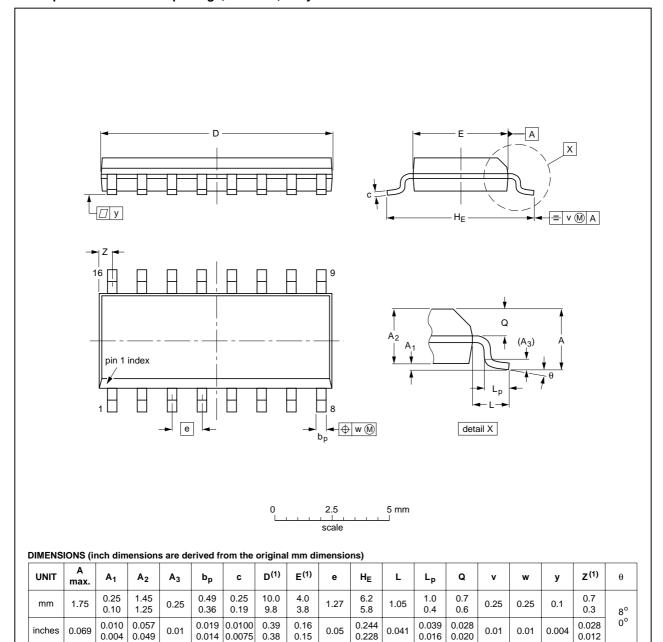


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14. Package outline

SO16: plastic small outline package; 16 leads; body width 3.9 mm

SOT109-1



Note

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

OUTLINE		REFER	ENCES	EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	JEITA	PROJECTION	1350E DATE	
SOT109-1	076E07	MS-012			99-12-27 03-02-19	

Fig 10. Package outline SOT109-1 (SO16)

Quad 1-of-2 video multiplexer/demultiplexer

SSOP16: plastic shrink small outline package; 16 leads; body width 3.9 mm; lead pitch 0.635 mm SOT519-1

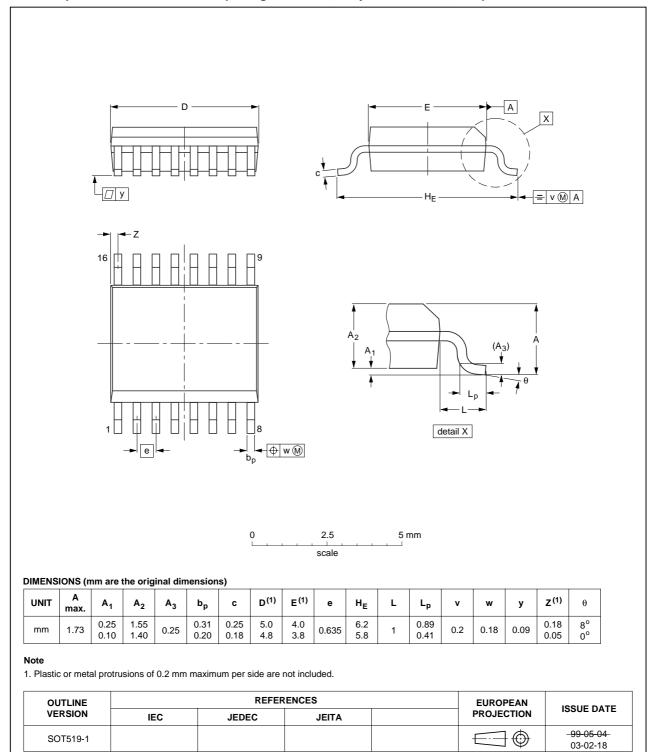


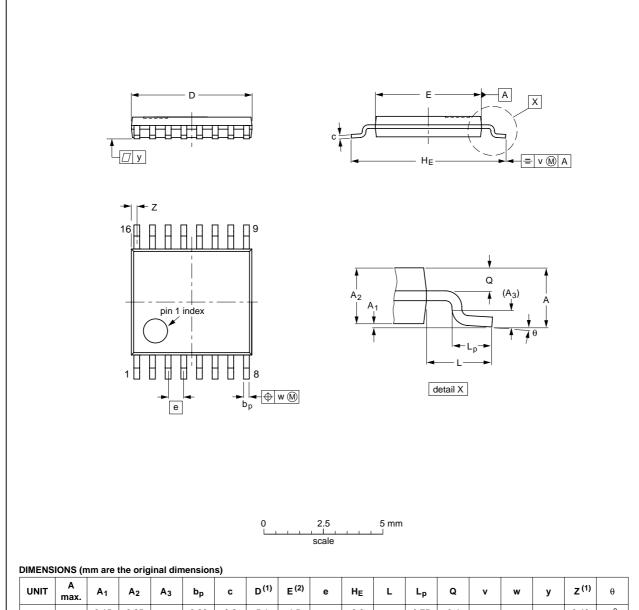
Fig 11. Package outline SOT519-1 (SSOP16)

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Quad 1-of-2 video multiplexer/demultiplexer

TSSOP16: plastic thin shrink small outline package; 16 leads; body width 4.4 mm

SOT403-1



UNI	Γ A max.	A ₁	A ₂	A ₃	bp	С	D ⁽¹⁾	E ⁽²⁾	е	HE	L	Lp	Q	v	w	у	Z ⁽¹⁾	θ
mm	1.1	0.15 0.05	0.95 0.80	0.25	0.30 0.19	0.2 0.1	5.1 4.9	4.5 4.3	0.65	6.6 6.2	1	0.75 0.50	0.4 0.3	0.2	0.13	0.1	0.40 0.06	8° 0°

Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

REFERENCES			EUROPEAN	ISSUE DATE	
IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
	MO-153				99-12-27 03-02-18
	IEC	IEC JEDEC	IEC JEDEC JEITA	IEC JEDEC JEITA	IEC JEDEC JEITA PROJECTION

Fig 12. Package outline SOT403-1 (TSSOP16)

Quad 1-of-2 video multiplexer/demultiplexer

15. Abbreviations

Table 11. Abbreviations

Acronym	Description
CDM	Charged Device Model
ESD	ElectroStatic Discharge
НВМ	Human Body Model
MM	Machine Model
TTL	Transistor-Transistor Logic

16. Revision history

Table 12. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
NX5DV330_2	20080825	Product data sheet	-	NX5DV330_1
Modifications:	 Section 3 "O 	rdering information": Table no	te reference added for	SSOP16 package.
NX5DV330_1	20080815	Product data sheet	-	-

Quad 1-of-2 video multiplexer/demultiplexer

17. Legal information

17.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
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Quad 1-of-2 video multiplexer/demultiplexer

19. Contents

1	General description
2	Features
3	Ordering information
4	Functional diagram 2
5	Pinning information 2
5.1	Pinning
5.2	Pin description
6	Functional description 3
7	Limiting values
8	Recommended operating conditions 4
9	Static characteristics 4
10	Dynamic characteristics 4
11	Waveforms
12	Additional dynamic characteristics 6
13	Test circuits 6
14	Package outline 8
15	Abbreviations11
16	Revision history
17	Legal information
17.1	Data sheet status
17.2	Definitions12
17.3	Disclaimers
17.4	Trademarks12
18	Contact information 12
19	Contents

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